Electromechanical Relay Switches Technical Data Sheet
PE71S6415

## Features

- Single P ole Double Throw SMT Relay S witch
- DC to 8 GHz Frequency Range
- 5M Cycle Min Operating Life (Cold Switching)
- +12 Volt DC
- Up to 40W Average Power (Hot S witching)
- $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ Operating Temperature
- Insertion Loss 1 dB Max
- VSWR 1.7:1 Max
- Latching Actuator
- Miniature True Surface Mount Package Design


## Applications

- High Performance Relay S witch
- Communications Systems
- Test \& Measurement
- ECM Equipment
- Tower Mount Amplifier


## Description

The PE71S6415 is a single pole double throw electromechanical relay switch that operates from DC to 8 GHz . The design features a latching actuator with 2 coils and has a long and reliable lifespan up to 5 M lifecycles typical (at low level) with excellent repeatability and thermal resistance. The innovative micro-mechanical design is in a miniature true surface mount package that's ideal for space limited applications. RF and command ports have gold plated access and the package can be mounted to a PWB using infrared reflow, forced air oven, or hand soldering processes. Impressive performance includes 1 dB max insertion loss, 1.7:1 VSWR, and 40 dB isolation. Input power handling for hot switching is rated up to 40W, and operating voltage is +12 Vdc with 58 mA operating current. Performance is guaranteed over $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and the switch assembly is RoHS and REACH compliant.

## Electrical Specifications

Switch Type
Actuator Type
Switching Sequence
Actuator Options

SPDT
Latching
Break Before Make
Hot Switching

|  | Description | DC | Typical | Maximum |
| :--- | :---: | :---: | :---: | :---: |
| Frequency Range |  | 18 | Units |  |
| Impedance | 10.2 | 50 |  | GHz |
| Operating Voltage |  | 12 | 13 | Ohms |
| Actuating Set Current @ 12 Volts | 58 |  | Volts |  |
| VSWR | 40 | $1.4: 1$ | $1.7: 1$ | mA |
| Insertion Loss | 0.6 | 1 |  |  |
| Isolation |  |  | dB |  |
| Coil Resistance | 205 | dB |  |  |
| Third Order Intermodulation | -110 |  | dBc |  |
| Input Power (CW) |  | 3 | Watts |  |

Click the following link (or enter part number in "SEARCH" on website) to obtain additional part information including price, inventory and certifications: SPDT Electromechanical Relay Latching Switch, DC to 18 GHz , up to 40W, 12V, Hot Switching, SMT, 5M Lifecycles PE 71S 6415

[^0]Sales@Pasternack.com •Techsupport@Pasternack.com

## SPDT Electromechanical Relay Latching Switch, DC to 18 GHz, up to 40W, 12V, Hot Switching, SMT, 5M Lifecycles

Electromechanical Relay Switches Technical Data
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| RF and command ports |  | gold plated access, infrared reflow, forced air oven or hand soldering (Compatible with "lead free" soldering processes) |  |
| :---: | :---: | :---: | :---: |
| Switching time (Nomial voltage) | Making contacts Breaking contacts Cold switching (Max 120 cycles/min) | Max 5 ms , including contact bounce time |  |
|  |  | 3 ms |  |
| Life |  | 3 million cycles ( 5 million cycles typical at low level) |  |
|  | Hot switching (Max 20 cycles/min) | 500.000 cycles (1W, impedance $50 \Omega$, V.S.W.R. <1.25) |  |
| Insulation |  | Dielectric test voltage | 300 Vms |
|  |  | Insulation resistance at 500Vdc | > 100MOhms |
| Environmental protection |  | "LEAD FREE » construction" <br> Waterproofness according to IEC 60529 / IP64 |  |
| Mass |  | 7.5g |  |
| Operating te (With no ici | perature range $\left({ }^{\circ} \mathrm{C}\right)$ nor condensation) | -40 to +85 |  |
| Storage ter | erature range ( ${ }^{\circ} \mathrm{C}$ ) | -55 to +85 |  |

Performance by Frequency

| Description | F1 | F2 | F3 | F4 | F5 | Units |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Frequency Range | DC to 3 | 3 to 6 | 6 to 8 | 8 to 12.4 | 12.4 to 18 | GHz |
| VSWR, Max | $1.2: 1$ | $1.35: 1$ | $1.4: 1$ | $1.5: 1$ | $1.7: 1$ |  |
| Insertion Loss, Max | 0.2 | 0.4 | 0.5 | 0.6 | 1 | dB |
| Isolation, Min | 50 | 40 | 40 | 40 | 40 | dB |
| Input Power, Typ (CW) | 40 | 25 | 5 | 3 | 1 | Watts |

Electrical Specification Notes:
Temperature: $+23^{\circ} \mathrm{C}$
Coil Resistance: +/-10\%
Third Order Intermodulation @ 1730 MHz (2 carries 20W)
At high frequency, manual soldering may generate spikes and RF characteristics degradation, due to air gaps between PC board and relay grounds

## Mechanical Specifications

## Size

Length 0.59 in [14.99 mm]
Width/Diameter
0.5 in [ 12.7 mm ]

Height
0.47 in [11.94 mm]

Weight
$0.05 \mathrm{lbs}[22.68 \mathrm{~g}]$
Package Type
Surface Mount

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[^1]SPDT Electromechanical Relay Latching Switch, DC to 18 GHz, up to 40W, 12V, Hot Switching, SMT, 5M Lifecycles

## Connectors

RF Connector Type SMT

## Environmental Specifications

Temperature
Operating Range
Storage Range
Shock

$$
-40 \text { to }+85 \text { deg } \mathrm{C}
$$

$$
-55 \text { to }+85 \text { deg C }
$$

Vibration
MIL STD 202, method 213B, Cond C
Sine Vibration

MIL STD 202, method 204
MIL STD 202, method 204, Con D (Operating)/(Cond G (Non-Operating)

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[^2]Phone: (866) 727-8376 or (949) 261-1920 • Fax: (949) 261-7451
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SPDT Electromechanical Relay Latching Switch, DC to 18 GHz, up to 40W, 12V, Hot Switching, SMT, 5M Lifecycles


## Electromechanical Relay Switches Technical Data

Compliance Certifications (see product page for current document)
Diagram


## Plotted and Other Data

Notes:

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Typical Performance Data



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RF POWER RATING FOR COLD SWITCHING USE
(Impedance 50 Ohms, V.S.W.R. <1.25)
Power level depends on environmental conditions :
The modules have been designed to be used without a cooling fan even for high power applications. However, the power capability may be still improved by using the appropriate cooling fan.


SPDT Electromechanical Relay Latching Switch, DC to 18 GHz , up to 40W, 12V, Hot Switching, SMT, 5M Lifecycles from Pasternack Enterprises has same day shipment for domestic and International orders. Our RF, microwave and millimeter wave products maintain a $99.4 \%$ availability and are part of the broadest selection in the industry.

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URL: https://www.pasternack.com/spdt-electromechanical-relay-latching-switch-18-ghz-3w-12v-hot-switching-smt-pe71s6415-p.aspx

The information contained in this document is accurate to the best of our knowledge and representative of the part described herein. It may be necessary to make modifications to the part and/or the documentation of the part, in order to implement improvements. Pasternack reserves the right to make such changes as required. Unless otherwise stated, all specifications are nominal. Pasternack does not make any representation or warranty regarding the suitability of the part described herein for any particular purpose, and Pasternack does not assume any liability arising out of the use of any part or documentation.



## RECOMMENDED SOLDERING PROCEDURE

A - Soldering procedure using automatic pick and place equipment

## 1-Solder paste :

Pasternack recommends using a « no clean - low residue \% solder cream ( $5 \%$ solid residue of flux quantity) that will permit the elimination of the cleaning operation step after soldering.
Note : Due to the gold plating of the switch PCB interface, it is important to use a paste made with silver. This will help in avoiding formation of intermetallics as part of the solder joint.

## 2-Solder paste deposition :

Solder cream may be applied on the board with screen printing or dispenser technologies. For either method, the solder paste must be coated to appropriate thickness and shapes to achieve good solder wetting. Please optically verify that the edges of the zone are clean and without contaminates, and that the PCB zoned areas have not oxydated. The design of the mounting pads and the stenciling area are available upon request, for a thickness of the silk-screen printing of $0.15 \mathrm{~mm}\left(0.006^{\circ}\right)$.

## 3-Placement of the component :

For small lightweight components such as chip components, a self-alignment effect can be expected if small placement errors exist. However, this effect is not as expected for relays components and they require a accurate positioning on their soldering pads, typically $+/-0.1 \mathrm{~mm}\left(+/-0.004^{\prime \prime}\right)$.
Place the relay onto the PCB with automatic pick and place equipment. Various types of suction can be used.
Pasternack does not recommend using adhesive agents on the component or on the PCB.

## 4-Soldering: infra-red process

Please follow the Pasternack recommended max temperature profile for infra-red reflow or forced air convection :


Higher temperature ( $\mathbf{2 6 0}{ }^{\circ} \mathrm{C}$ ) and longer process duration would damage permanently the switches.

## 5-Cleaning procedure :

On miniature relays, high frequency cleaning may cause the contacts to stick. If cleaning is needed, please avoid ultrasonic cleaning and use alcohol based cleaning solutions.
 In-line cleaning process, spraying, immersion, especially under temperature, may cause a risk of degradation of internal contacts. For such cleaning process please contact us.

## 6-Quality check :

Verify by visual inspection that the component is centred on the mounting pads.
Solder joints : verify by visual inspection that the formation of meniscus on the pads are proper.

## B - Soldering procedure by manual operation

: manual soldering is not recommended for high frequencies, as it generates resonance and lower RF characteristics due to gaps between PC board and relay grounds,.

## 1-Solder paste and flux deposition :

Refer to procedure A-1
Deposit a thin layer of flux on solder pad area. Allow the flux to evaporate a few seconds before applying the solder paste, it will prevent dilution of the paste.

## 2-Solder paste deposifion :

Pasternack recommends depositing a small amount of solder paste on solder pad area by syringe, according to the manual soldering pattern (available upon request).
Be careful, not to apply solder paste outside of the zone area.

## 3-Placement of the component:

During manipulation, avoid contaminating gold surfaces by contact with fingers.
Place the component on the mounting zone by pressing on the top of the relay lid.

4-Hand soldering:
Iron wattage 30 to 60 W .
To keep better RF characteristics, apply pressure on the relay lid during all the soldering stage, so as to reduce the air gap between the PC board and the relay.
If possible, fix the ground plane of the relay on the board with two M1.2 screws before the soldering stage. On each side of the central RF access, the RF body edge must be soldered to the ground of the PC board. To improve RF characteristics and avoid soldering the RF body on the ground, a conductive gasket may be used (please contact us for detailed application note).

5-Cleaning procedure :
Refer to procedure A -5 .

## 6-Quality check:

Verify by visual inspection that component is centred on the mounting pads.
Solder joints : verify by visual inspection that there is no solder excess on the RF pads.


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